Döcket No.: GR 00 P 1679

2829

I be reby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231, on the date indicated below.

Ву:____

Date: April 28, 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

Dieter Kantz et al.

Applic. No.

09/826,594

Filed

April 5, 2001

Title

Test Configuration for the Functional Testing of a

Semiconductor Chip

Examiner :

Ernest F. Karlsen

Art Unit: 2829

<u>INFORMATION DISCLOSURE STATEMENT</u> <u>UNDER 37 C.F.R. 1.97(C)(1)</u>

Hon. Commissioner of Patents and Trademarks, Washington, D.C. 20231

Sir:

In accordance with 37 C.F.R. 1.98 copies of the following patents and/or publications are submitted herewith:

United States Patent No. 5,130,645 (Levy), dated July 14, 1992;

Korean Office Action dated March 12, 2003.

In accordance with 37 C.F.R. 1.97(e) the undersigned herewith states that each item of information contained in the information disclosure statement was first cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement.

If no translation of pertinent portions of any foreign language patents or publications mentioned above is included with the aforementioned copies of those applications, patents and/or publications, it is because no existing translation is readily available to the applicant.

In accordance with 37 C.F.R. 1.97 (c) (1), consideration of this Information Disclosure Statement is requested.

Respectfully submitted,

For Applicants

Date: April 28, 2003

Lerner And Greenberg, P.A. Post Office Box 2480 Hollywood, FL 33022-2480

Tel: (954) 925-1100 Fax: (954) 925-1101

/bmb

•

Mark P. Weichselbaum Reg. No. 43,248 MAY 0 7 2003

FORM PTO-1449 (SUBSTITUTE)

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE

INFORMATION DISCLOSURE STATEMENT BY APPLICANT (37 CFR 1.98(b))

Attorney	Docket	No.:
CDAA	D 1670	`

Applic. No.

09/826,594

Applicant

Dieter Kantz et al.

Filing Date April 5, 2001 Group Art Unit

2829

U.S. PATENT DOCUMENTS

L							
EXAMINER INITIALS		PATENT NO.	DATE	PATENTEE	CLASS	SUB CLASS	FILING DATE
	Α	5,130,645	07/14/92	Levy			
	В						
	С						
	D						
	E						
	F						
	G						
	Н						
	1						

FOREIGN PATENT DOCUMENT

	DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB CLASS	TRAI YES	
J							
К							
L							
М				1			
N							

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)

	0	
	1	
	Р	
]	
İ	į į	

EXAMINER

DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

Notice to File a Response

Applicant's Name:

Infineon Technologies AG

Attorney's Name:

Sang-sun NAM

Patent Appln. No.:

10-2001-0017980

Title of Invention:

Test arrangement for testing function of a semiconductor

chip

We hereby inform you of the following reason(s) for rejection pursuant to Article 63 of the Korean Patent Act. The applicant, if needed, may file an argument and an amendment no later than May 12, 2003.

REASON

Since the invention in claim 1 of the present application could have been easily conceived from the document indicated below prior to the filing of the present application by a person having ordinary knowledge in the art to which the present invention pertains, the present invention cannot be patented according to Article 29(2) of the Korean Patent Act.

DETAILED GROUNDS

Claim 1 of the present invention relates to a test configuration having a self-test unit, comprising a power source connected to the semiconductor chip. However, USP 5,130,645 (July 14, 1992) discloses a built-in self-test structure, comprising a power supply circuit connected to a semiconductor chip. Thus, the invention of claim 1 of the present invention could have been easily conceived from the cited invention.

[Attachment]

1. A copy of USP 5,130,645 (July 14, 1992)

Date: March 12, 2003 Examiner: J. W. OH Examination Bureau IV

Korean Intellectual Property Office